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## What is "[Embedded - Microcontrollers](#)"?

"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

## Applications of "[Embedded - Microcontrollers](#)"

### Details

Product Status	Discontinued at Digi-Key
Core Processor	Z8
Core Size	8-Bit
Speed	8MHz
Connectivity	-
Peripherals	Brown-out Detect/Reset, HLVD, POR, WDT
Number of I/O	24
Program Memory Size	16KB (16K x 8)
Program Memory Type	OTP
EEPROM Size	-
RAM Size	237 x 8
Voltage - Supply (Vcc/Vdd)	2V ~ 3.6V
Data Converters	-
Oscillator Type	Internal
Operating Temperature	0°C ~ 70°C (TA)
Mounting Type	Through Hole
Package / Case	28-DIP (0.600", 15.24mm)
Supplier Device Package	28-PDIP
Purchase URL	<a href="https://www.e-xfl.com/product-detail/analog-devices/zlp32300p2816c">https://www.e-xfl.com/product-detail/analog-devices/zlp32300p2816c</a>

## Revision History

Each instance in the Revision History table reflects a change to this document from its previous revision. For more details, refer to the corresponding pages or appropriate link in the table.

Date	Revision Level	Description	Page Number
February 2008	23	Updated <a href="#">Ordering Information</a> section.	<a href="#">87</a>
January 2008	22	Updated <a href="#">Ordering Information</a> section.	<a href="#">87</a>
July 2007	21	Updated Disclaimer section and implemented style guide.	All
February 2007	20	Updated <a href="#">Low-Voltage Detection</a> .	<a href="#">58</a>
May 2006	19	Updated <a href="#">Figure 33</a> with pin P22 in SMR block input.	<a href="#">52</a>
December 2005	18	Updated <a href="#">Clock</a> and <a href="#">Input/Output Ports</a> sections.	15 and 51

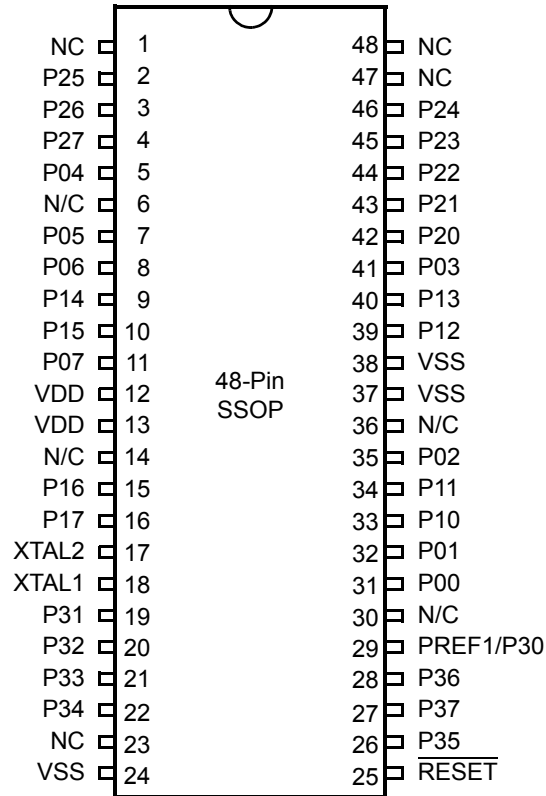
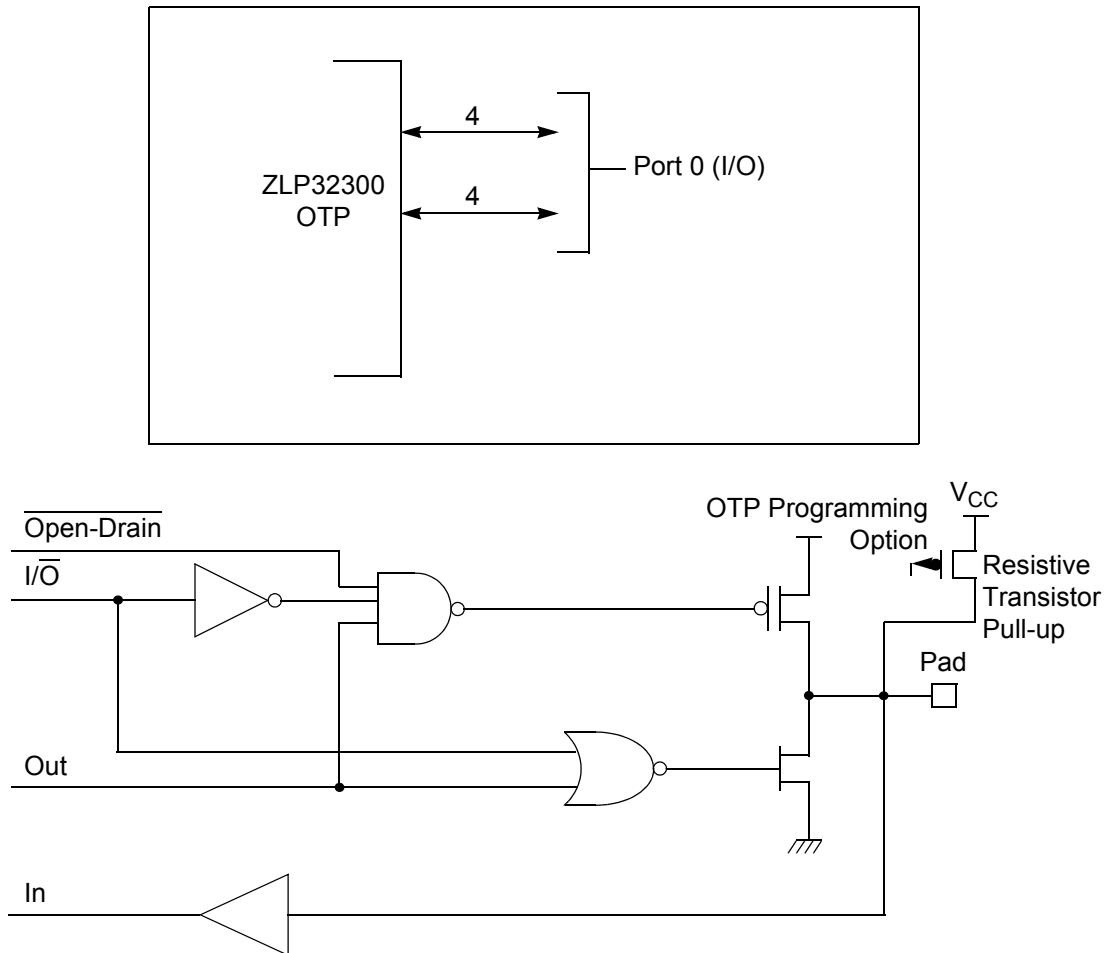


Figure 6. 48-Pin SSOP Pin Configuration

Table 5. 40- and 48-Pin Configuration

40-Pin PDIP No	48-Pin SSOP No	Symbol
26	31	P00
27	32	P01
30	35	P02
34	41	P03
5	5	P04
6	7	P05
7	8	P06
10	11	P07
28	33	P10
29	34	P11

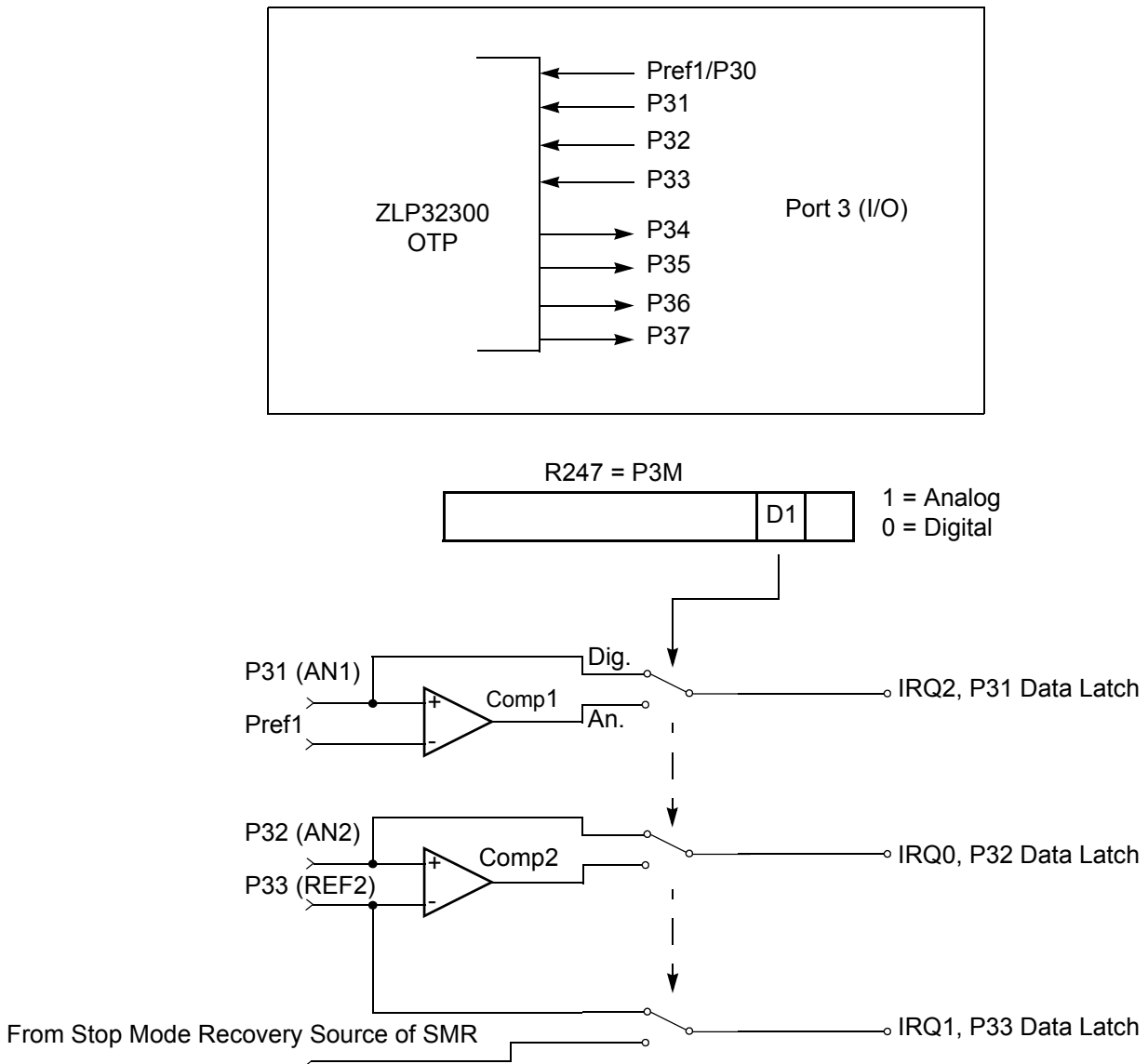


**Figure 7. Port 0 Configuration**

### Port 1 (P17–P10)

Port 1 can be configured for standard port input or output mode (see [Figure 8](#)). After POR or Stop Mode Recovery, Port 1 is configured as an input port. The output drivers are either push-pull or open-drain and are controlled by bit D1 in the PCON register.

- **Notes:**
1. The Port 1 direction is reset to be input following an SMR.
  2. In 20- and 28-pin packages, Port 1 is reserved. A write to this register will have no effect and will always read FF.



**Figure 10. Port 3 Configuration**

Two on-board comparators process analog signals on P31 and P32, with reference to the voltage on Pref1 and P33. The Analog function is enabled by programming the Port 3 Mode Register (bit 1). P31 and P32 are programmable as rising, falling, or both edge triggered interrupts (IRQ register bits 6 and 7). Pref1 and P33 are the comparator reference voltage inputs. Access to the Counter Timer edge-detection circuit is through P31 or P20

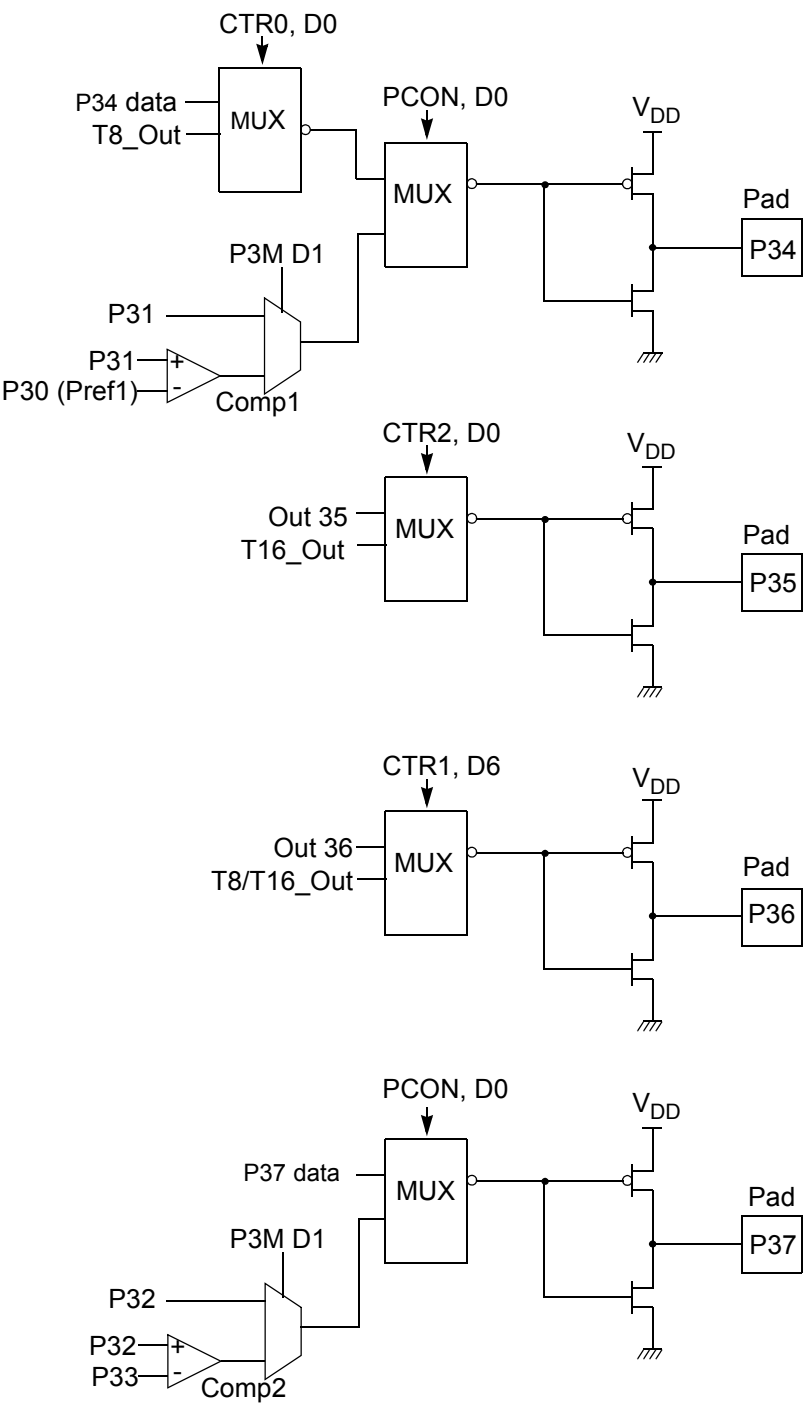


Figure 11. Port 3 Counter/Timer Output Configuration

# Functional Description

This device incorporates special functions to enhance the Z8 functionality in consumer and battery-operated applications.

## Program Memory

This device addresses 32 KB of OTP memory. The first 12 bytes are reserved for interrupt vectors. These locations contain the six 16-bit vectors that correspond to the six available interrupts. See [Figure 12](#).

## RAM

This device features 256 B of RAM.

register RP select the working register group. Bits 3–0 of register RP select the expanded register file bank.

► **Note:** *An expanded register bank is also referred to as an expanded register group (see [Figure 13](#)).*



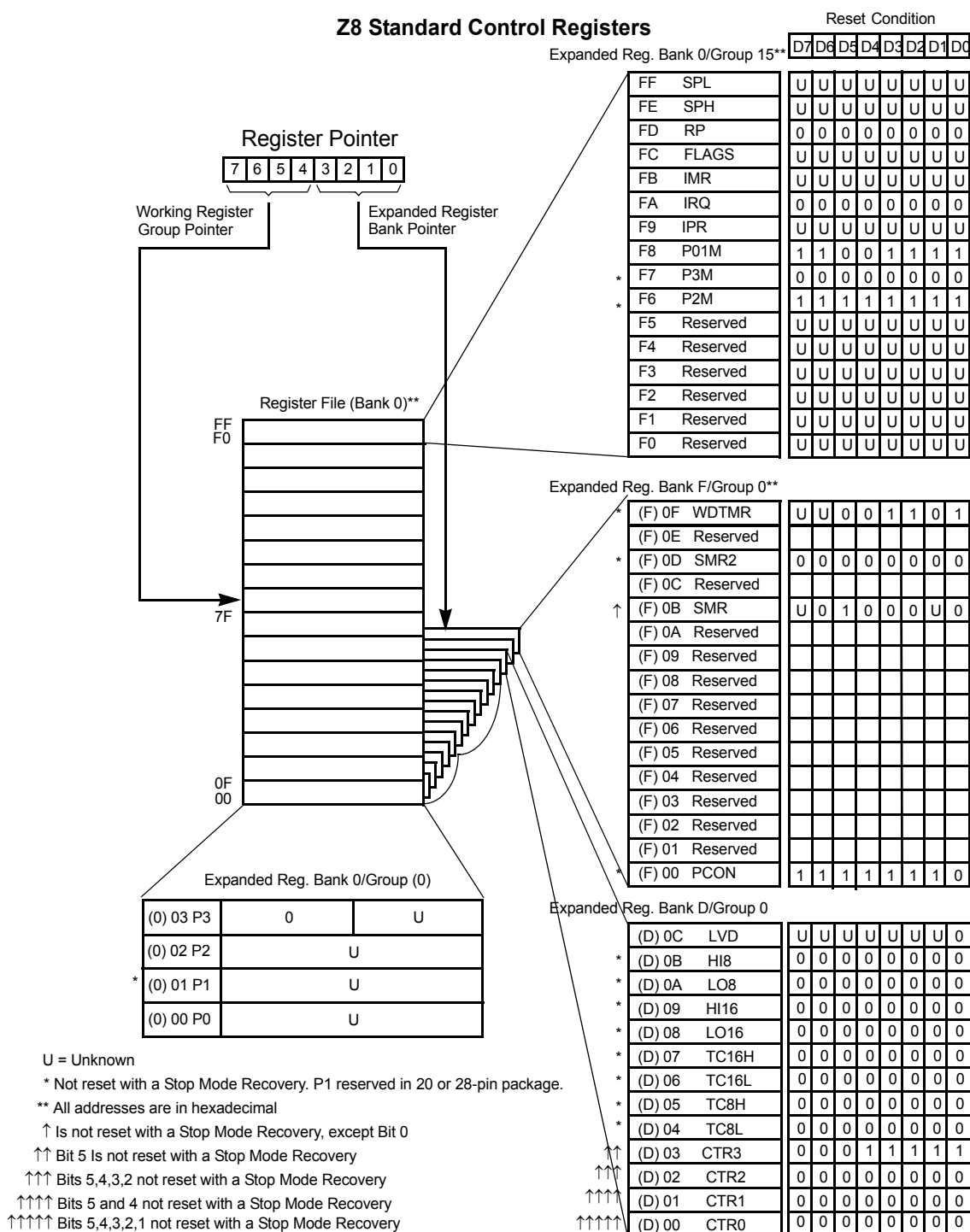


Figure 13. Expanded Register File Architecture

**Counter/Timer8 High Hold Register—TC8H(D)05h**

Field	Bit Position	Description
T8_Level_HI	[7:0]	R/W Data

**Counter/Timer8 Low Hold Register—TC8L(D)04h**

Field	Bit Position	Description
T8_Level_LO	[7:0]	R/W Data

**CTR0 Counter/Timer8 Control Register—CTR0(D)00h**

Table 7 lists and briefly describes the fields for this register.

**Table 7. CTR0(D)00h Counter/Timer8 Control Register**

Field	Bit Position		Value	Description
T8_Enable	7-----	R/W	0* 1 0 1	Counter Disabled Counter Enabled Stop Counter Enable Counter
Single/Modulo-N	-6-----	R/W	0* 1	Modulo-N Single Pass
Time_Out	--5-----	R/W	0** 1 0 1	No Counter Time-Out Counter Time-Out Occurred No Effect Reset Flag to 0
T8_Clock	---43---	R/W	0 0** 0 1 1 0 1 1	SCLK SCLK/2 SCLK/4 SCLK/8
Capture_INT_Mask	----2--	R/W	0** 1	Disable Data Capture Interrupt Enable Data Capture Interrupt
Counter_INT_Mask	-----1-	R/W	0** 1	Disable Time-Out Interrupt Enable Time-Out Interrupt
P34_Out	-----0	R/W	0* 1	P34 as Port Output T8 Output on P34

\*Indicates the value upon Power-On Reset.

\*\*Indicates the value upon Power-On Reset. Not reset with a Stop Mode Recovery.

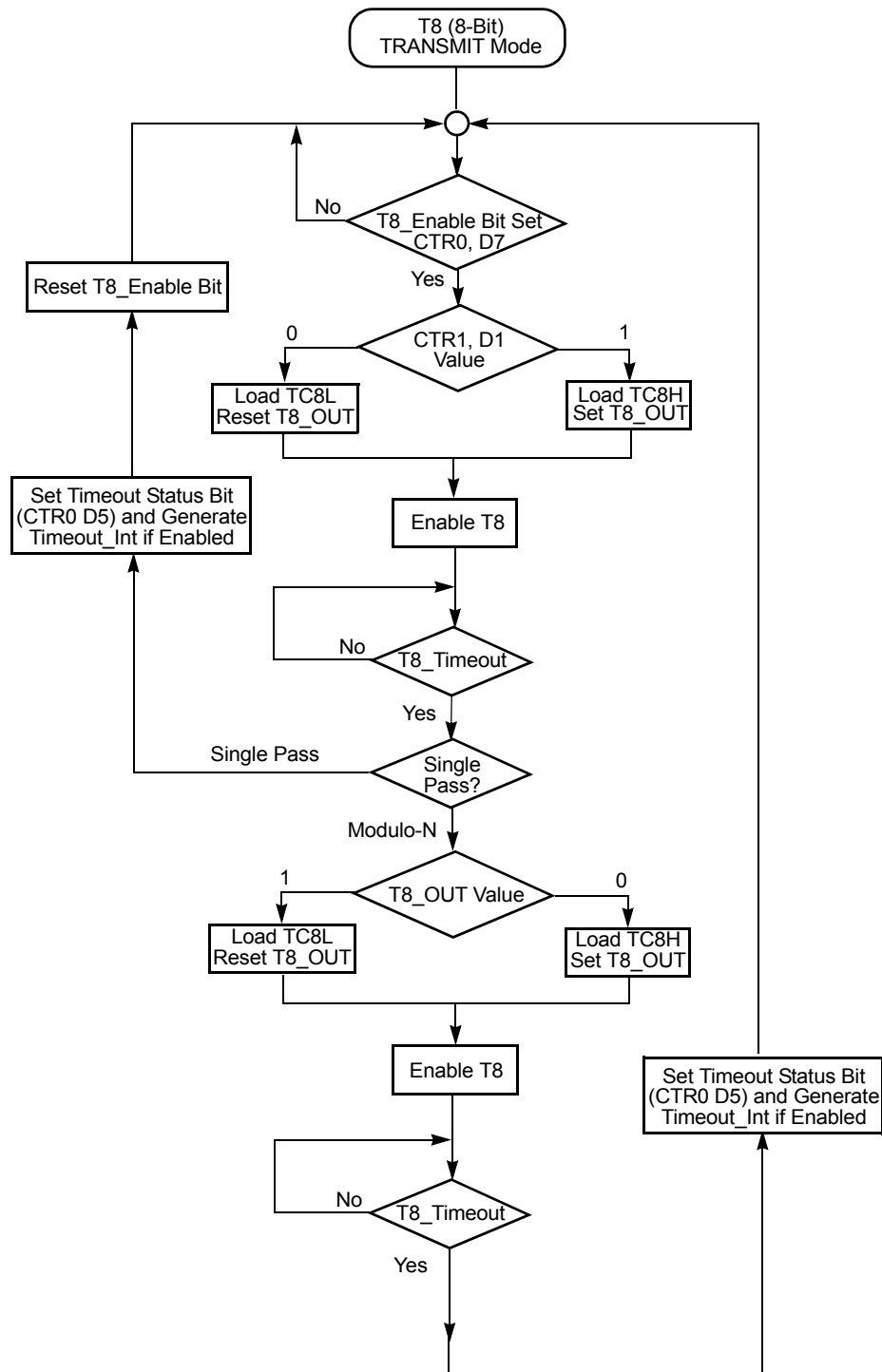
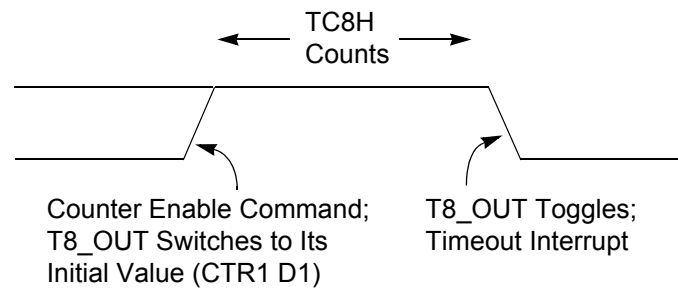


Figure 17. TRANSMIT Mode Flowchart

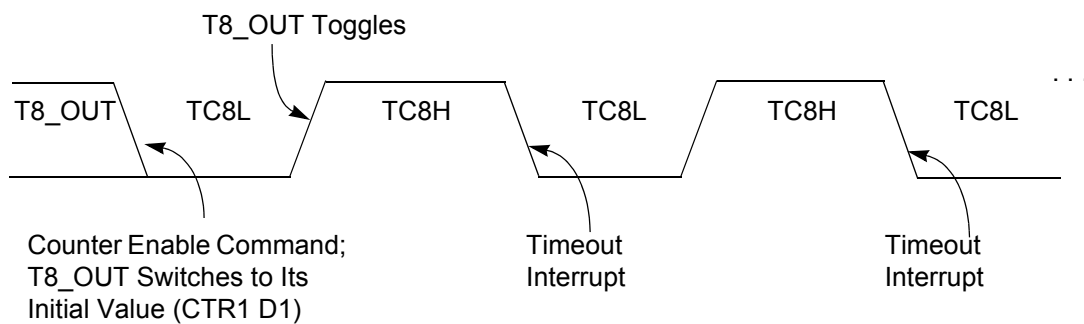


**Caution:** *Using the same instructions for stopping the counter/timers and setting the status bits is not recommended.*

Two successive commands are necessary. First, the counter/timers must be stopped. Second, the status bits must be reset. These commands are required because it takes one counter/timer clock interval for the initiated event to actually occur, see [Figure 19](#) and [Figure 20](#).



**Figure 19. T8\_OUT in SINGLE-PASS Mode**



**Figure 20. T8\_OUT in MODULO-N Mode**

### T8 DEMODULATION Mode

You must program TC8L and TC8H to FFh. After T8 is enabled, when the first edge (rising, falling, or both depending on CTR1, D5; D4) is detected, it starts to count down. When a subsequent edge (rising, falling, or both depending on CTR1, D5; D4) is detected during counting, the current value of T8 is complemented and put into one of the capture registers. If it is a positive edge, data is put into LO8; if it is a negative edge, data is put into HI8. From that point, one of the edge detect status bits (CTR1, D1; D0) is set, and an interrupt can be generated if enabled (CTR0, D2). Meanwhile, T8 is loaded with FFh and starts counting again. If T8 reaches 0, the time-out status bit (CTR0, D5) is set, and an

This T16 mode is generally used to measure space time, the length of time between bursts of carrier signal (marks).

#### If D6 of CTR2 Is 1

T16 ignores the subsequent edges in the input signal and continues counting down. A timeout of T8 causes T16 to capture its current value and generate an interrupt if enabled (CTR2, D2). In this case, T16 does not reload and continues counting. If the D6 bit of CTR2 is toggled (by writing a 0 then a 1 to it), T16 captures and reloads on the next edge (rising, falling, or both depending on CTR1, D5; D4), continuing to ignore subsequent edges.

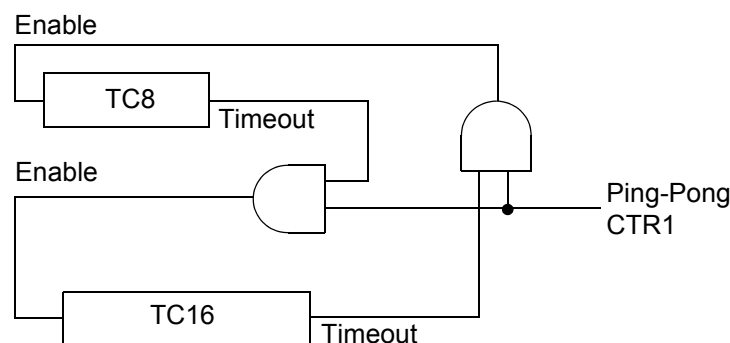
This T16 mode generally measures mark time, the length of an active carrier signal burst.

If T16 reaches 0, T16 continues counting from  $FFFFh$ . Meanwhile, a status bit (CTR2 D5) is set, and an interrupt timeout can be generated if enabled (CTR2 D1).

#### PING-PONG Mode

This operation mode is only valid in TRANSMIT mode. T8 and T16 must be programmed in SINGLE-PASS mode (CTR0, D6; CTR2, D6), and PING-PONG mode must be programmed in CTR1, D3; D2. You can begin the operation by enabling either T8 or T16 (CTR0, D7 or CTR2, D7). For example, if T8 is enabled, T8\_OUT is set to this initial value (CTR1, D1). According to T8\_OUT's level, TC8H or TC8L is loaded into T8. After the terminal count is reached, T8 is disabled, and T16 is enabled. T16\_OUT then switches to its initial value (CTR1, D0), data from TC16H and TC16L is loaded, and T16 starts to count. After T16 reaches the terminal count, it stops, T8 is enabled again, repeating the entire cycle. Interrupts can be allowed when T8 or T16 reaches terminal control (CTR0, D1; CTR2, D1). To stop the Ping-Pong operation, write 00 to bits D3 and D2 of CTR1, see [Figure 26](#).

► **Note:** *Enabling Ping-Pong operation while the counter/timers are running might cause intermittent counter/timer function. Disable the counter/timers and reset the status Flags before instituting this operation.*



**Figure 26. PING-PONG Mode Diagram**

For both resonator and crystal oscillator, the oscillation ground must go directly to the ground pin of the microcontroller. The oscillation ground must use the shortest distance from the microcontroller ground pin and it must be isolated from other connections.

## Power Management

### Power-On Reset

A timer circuit clocked by a dedicated on-board RC-oscillator is used for the Power-On Reset timer function. The POR time allows  $V_{DD}$  and the oscillator circuit to stabilize before instruction execution begins.

The POR timer circuit is a one-shot timer triggered by one of three conditions:

- Power Fail to Power OK status, including Waking up from  $V_{BO}$  Standby
- Stop Mode Recovery (if D5 of SMR = 1)
- WDT Timeout

The POR timer is 2.5 ms minimum. Bit 5 of the Stop Mode Register determines whether the POR timer is bypassed after Stop Mode Recovery (typical for external clock).

### HALT Mode

This instruction turns off the internal CPU clock, but not the XTAL oscillation. The counter/timers and external interrupts IRQ0, IRQ1, IRQ2, IRQ3, IRQ4, and IRQ5 remain active. The devices are recovered by interrupts, either externally or internally generated. An interrupt request must be executed (enabled) to exit HALT Mode. After the interrupt service routine, the program continues from the instruction after HALT Mode.

### STOP Mode

This instruction turns OFF the internal clock and external crystal oscillation, reducing the standby current to 10  $\mu$ A or less. STOP mode is terminated only by a reset, such as WDT time-out, POR or SMR. This condition causes the processor to restart the application program at address 000Ch. To enter STOP (or HALT) mode, first flush the instruction pipeline to avoid suspending execution in mid-instruction. Execute a NOP (Opcode = FFh) immediately before the appropriate sleep instruction, as follows:

FF	NOP	; clear the pipeline
6F	STOP	; enter Stop Mode

or

FF	NOP	; clear the pipeline
7F	HALT	; enter HALT Mode

**Table 14. Stop Mode Recovery Source**

SMR:432			Operation
D4	D3	D2	Description of Action
0	0	0	POR and/or external reset recovery
0	0	1	Reserved
0	1	0	P31 transition
0	1	1	P32 transition
1	0	0	P33 transition
1	0	1	P27 transition
1	1	0	Logical NOR of P20 through P23
1	1	1	Logical NOR of P20 through P27

- **Note:** Any Port 2 bit defined as an output drives the corresponding input to the default state. For example, if the NOR of P23-P20 is selected as the recovery source and P20 is configured as an output, the remaining SMR pins (P23-P21) form the NOR equation. This condition allows the remaining inputs to control the AND/OR function, refer to SMR2 register on page 54 for other recover sources.

**Stop Mode Recovery Delay Select (D5)**

This bit, if low, disables the  $T_{POR}$  delay after Stop Mode Recovery. The default configuration of this bit is 1. If the ‘fast’ wake up is selected, the Stop Mode Recovery source must be kept active for at least 10  $T_{pC}$ .

- **Note:** This bit must be set to 1 if a crystal or resonator clock source is used. The  $T_{POR}$  delay allows the clock source to stabilize before executing instructions.

**Stop Mode Recovery Edge Select (D6)**

A 1 in this bit position indicates that a High level on any one of the recovery sources wakes the Crimzon ZLP32300 from STOP mode. A 0 indicates Low level recovery. The default is 0 on POR.

**Cold or Warm Start (D7)**

This bit is read only. It is set to 1 when the device is recovered from STOP mode. The bit is set to 0 when the device reset is other than Stop Mode Recovery.

### Voltage Detection and Flags

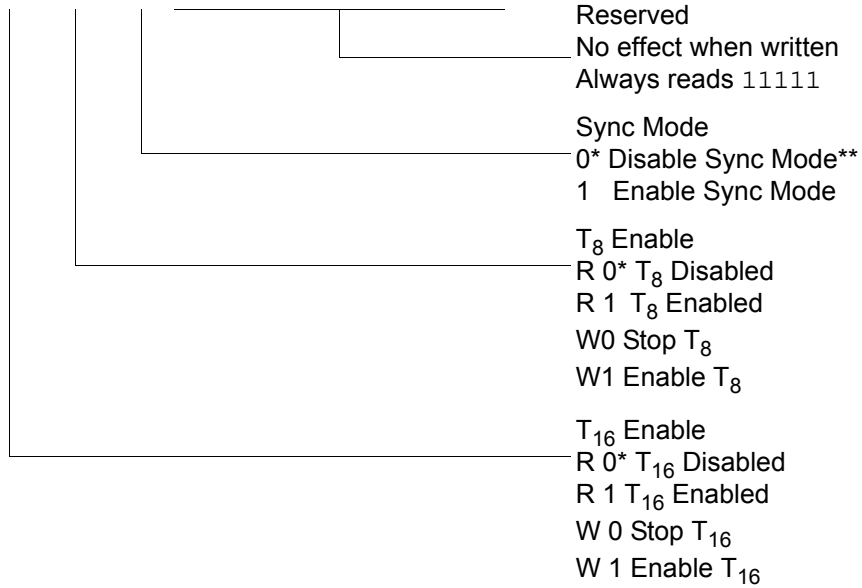
The Voltage Detection register (LVD, register 0Ch at the expanded register bank 0Dh) offers an option of monitoring the  $V_{CC}$  voltage. The Voltage Detection is enabled when bit 0 of LVD register is set. Once Voltage Detection is enabled, the  $V_{CC}$  level is monitored in real time. The HVD Flag (bit 2 of the LVD register) is set only if  $V_{CC}$  is higher than  $V_{HVD}$ . The LVD Flag (bit 1 of the LVD register) is set only if  $V_{CC}$  is lower than the  $V_{LVD}$ . When Voltage Detection is enabled, the LVD Flag also triggers IRQ5. The IRQ bit 5 latches the low-voltage condition until it is cleared by instructions or reset. The IRQ5 interrupt is served if it is enabled in the IMR register. Otherwise, bit 5 of IRQ register is latched as a Flag only.

- **Note:** *If it is necessary to receive an LVD interrupt upon power-up at an operating voltage lower than the low battery detect threshold, enable interrupts using the Enable Interrupt (EI) instruction prior to enabling the voltage detection.*



CTR3(0D)03H

D7	D6	D5	D4	D3	D2	D1	D0
----	----	----	----	----	----	----	----



\*Default setting after reset.

\*\*Default setting after reset. Not reset with a Stop Mode Recovery.

**Figure 40. T8/T16 Control Register (0D)03H: Read/Write (Except Where Noted)**

► **Note:** *If Sync Mode is enabled, the first pulse of T8 carrier is always synchronized with T16 (demodulated signal). It can always provide a full carrier pulse.*

## Capacitance

Table 18 lists the capacitances.

**Table 18. Capacitance**

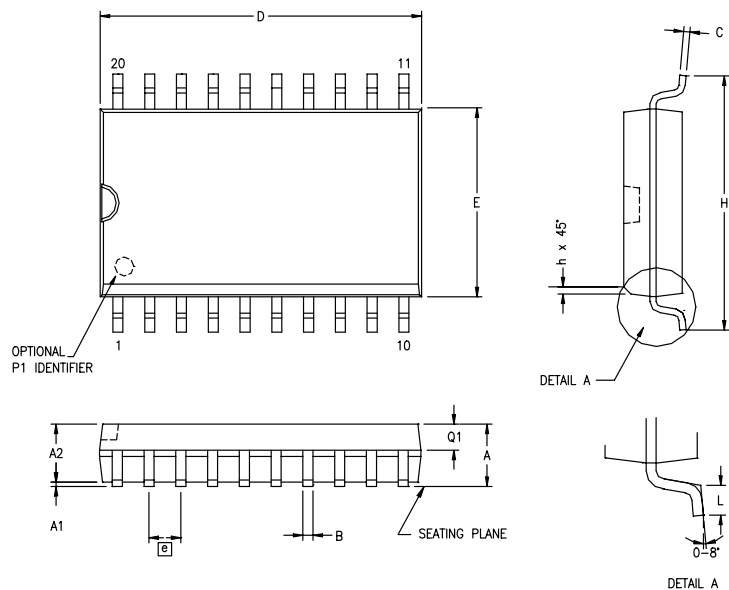
Parameter	Maximum
Input capacitance	12 pF
Output capacitance	12 pF
I/O capacitance	12 pF
$T_A = 25\text{ }^{\circ}\text{C}$ , $V_{CC} = \text{GND} = 0\text{ V}$ , $f = 1.0\text{ MHz}$ , unmeasured pins returned to GND	

## DC Characteristics

Table 19 describes the DC characteristics.

**Table 19. DC Characteristics**

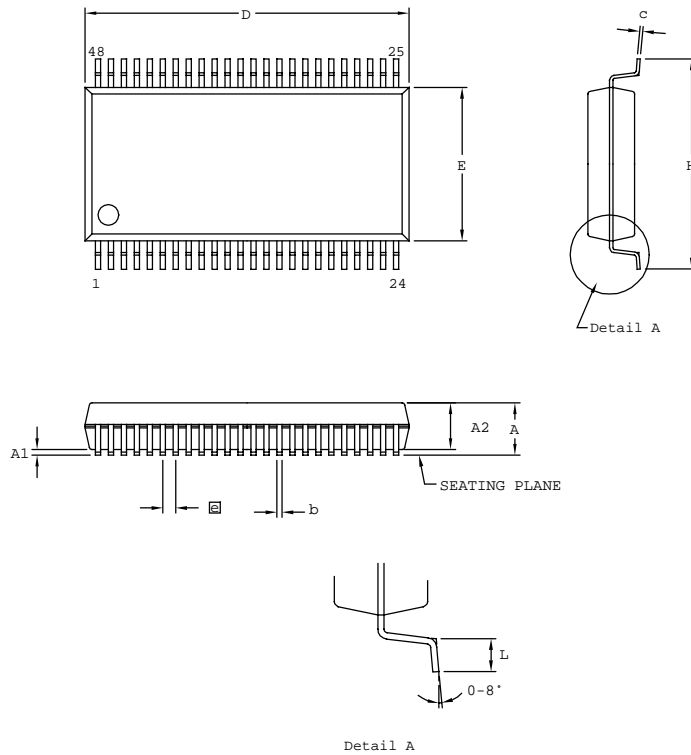
Symbol	Parameter	$V_{CC}$	$T_A = 0\text{ }^{\circ}\text{C to } +70\text{ }^{\circ}\text{C}$			Units	Conditions	Notes
			Min	Typ <sup>(7)</sup>	Max			
$V_{CC}$	Supply Voltage		2.0		3.6	V	See Notes	5
$V_{CH}$	Clock Input High Voltage	2.0-3.6	$0.8 V_{CC}$		$V_{CC}+0.3$	V	Driven by External Clock Generator	
$V_{CL}$	Clock Input Low Voltage	2.0-3.6	$V_{SS}-0.3$		0.4	V	Driven by External Clock Generator	
$V_{IH}$	Input High Voltage	2.0-3.6	$0.7 V_{CC}$		$V_{CC}+0.3$	V		
$V_{IL}$	Input Low Voltage	2.0-3.6	$V_{SS}-0.3$		$0.2 V_{CC}$	V		
$V_{OH1}$	Output High Voltage	2.0-3.6	$V_{CC}-0.4$			V	$I_{OH} = -0.5\text{ mA}$	
$V_{OH2}$	Output High Voltage (P36, P37, P00, P01)	2.0-3.6	$V_{CC}-0.8$			V	$I_{OH} = -7\text{ mA}$	
$V_{OL1}$	Output Low Voltage	2.0-3.6			0.4	V	$I_{OL} = 4.0\text{ mA}$	
$V_{OL2}$	Output Low Voltage (P00, P01, P36, P37)	2.0-3.6			0.8	V	$I_{OL} = 10\text{ mA}$	
$V_{OFFSET}$	Comparator Input Offset Voltage	2.0-3.6			25	mV		
$V_{REF}$	Comparator Reference Voltage	2.0-3.6	0		$V_{CC}$ -1.75	V		



SYMBOL	MILLIMETER		INCH	
	MIN	MAX	MIN	MAX
A	2.40	2.65	.094	.104
A1	0.10	0.30	.004	.012
A2	2.24	2.44	.088	.096
B	0.36	0.46	.014	.018
C	0.23	0.30	.009	.012
D	12.60	12.95	.496	.510
E	7.40	7.60	.291	.299
⌀	1.27 BSC		.050 BSC	
H	10.00	10.65	.394	.419
h	0.30	0.40	.012	.016
L	0.60	1.00	.024	.039
Q1	0.97	1.07	.038	.042

CONTROLLING DIMENSIONS : MM  
LEADS ARE COPLANAR WITHIN .004 INCH.

Figure 59. 20-Pin SOIC Package Diagram



SYMBOL	MILLIMETER		INCH	
	MIN	MAX	MIN	MAX
A	2.41	2.79	0.095	0.110
A1	0.23	0.38	0.009	0.015
A2	2.18	2.39	0.086	0.094
b	0.20	0.34	0.008	0.0135
c	0.13	0.25	0.005	0.010
D	15.75	16.00	0.620	0.630
E	7.39	7.59	0.291	0.299
ⓐ	0.635 BSC		0.025 BSC	
H	10.16	10.41	0.400	0.410
L	0.51	1.016	0.020	0.040

CONTROLLING DIMENSIONS : MM  
LEADS ARE COPLANAR WITHIN .004 INCH

**Figure 65. 48-Pin SSOP Package Design**

► **Note:** Contact Zilog<sup>®</sup> on the actual bonding diagram and coordinate for chip-on-board assembly.

Device	Part Number	Description
	ZLP32300P2008G	20-pin PDIP 8 K OTP
	ZLP32300S2008G	20-pin SOIC 8 K OTP
	ZLP32300H4804G	48-pin SSOP 4 K OTP
	ZLP32300P4004G	40-pin PDIP 4 K OTP
	ZLP32300H2804G	28-pin SSOP 4 K OTP
	ZLP32300P2804G	28-pin PDIP 4 K OTP
	ZLP32300S2804G	28-pin SOIC 4 K OTP
	ZLP32300H2004G	20-pin SSOP 4 K OTP
	ZLP32300P2004G	20-pin PDIP 4 K OTP
	ZLP32300S2004G	20-pin SOIC 4 K OTP
	ZLP323ICE01ZAC*	40-PDIP/48-SSOP Accessory Kit
	Note: *ZLP323ICE01ZAC has been replaced by an improved version, ZCRMZNICE02ZACG.	
	ZLP128ICE01ZEMG	In-Circuit Emulator
	Note: *ZLP128ICE01ZEMG has been replaced by an improved version, ZCRMZNICE01ZEMG.	
	ZCRMZNICE01ZEMG	Crimzon In-Circuit Emulator
	ZCRMZN00100KITG	Crimzon In-Circuit Emulator Development Kit
	ZCRMZNICE01ZACG	20-Pin Accessory Kit
	ZCRMZNICE02ZACG	40/48-Pin Accessory Kit

**Notes**

1. Replace C with G for Lead-Free Packaging.
2. Contact [www.zilog.com](http://www.zilog.com) for the die form.

For fast results, contact your local Zilog® sales office for assistance in ordering the part(s) desired.